



APPLICATION GUIDE







Introduction

Exploring Emerging Smart City Opportunities

• Dynamics such as a growing population, an increasing elderly demographic, greater urbanization, plus rising pollution are all putting acute pressures on people's everyday lives. Society must look at what can be done to help enrich modern living conditions and make the world a better place for future generations to inhabit. This can be achieved by utilizing smart technology.

• Across the globe, a multitude of smart city projects are now under way. These are enabling air quality issues to be tackled and traffic congestion to be addressed. They are making public transport more efficient, augmenting industrial processes, boosting farming production, enhancing healthcare services and making homes more comfortable and secure.

 Through smart city initiatives, municipal governments and utility companies are improving the services that they provide, while also reducing their capital and operational expenditure.

It must be acknowledged that every smart city implementation is distinct. Each will have different aspects that need to be considered and present its own specific problems to overcome. This means that having access to a broad range of different electronic components will be required in order to develop fully effective solutions.

 Murata has already built up a strong reputation in the various application areas that this guide discusses. There are a broad selection of Murata products that can be specified for smart city deployment, with details being given in the following pages.



Contents

Overview Technological trends Challenges

Smart Agriculture Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







Overview

Global Smart Cities Market Expanding Rapidly

 Projections from industry analysts Frost & Sullivan estimate that the global smart cities market will experience a compound annual growth rate (CAGR) of approximately 19% over the coming years.

• There has already been widespread investment in smart city projects throughout Europe, and further projects are currently being planned. Among the cities where most activity has been seen are Barcelona, London and Amsterdam.

 Among the most important features of smart cities are environment monitoring, surveillance, resource management, more efficient farming, manufacturing with higher productivity levels and greater efficiency of healthcare systems. These will help to improve residents' quality of life, as well as enhancing the performance of public services.



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Smart Cities Market, in USD Billion, Between 2019-2026F

Contents

Overview Technological trends Challenges Smart Agriculture Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building Smart Infrastructure





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Rapid Urbanization

Emerging Mega Trends



Urban Population

According to Statista, approximately 62.5% of the population will be living in the cities by 2050, as compared to 51% in 2010. Figures compiled by the World Health Organization (WHO) give very similar projections.



Megacities

A study published by the United Nations (UN) states that, by 2030, the world will have a total of 43 megacities (i.e. ones with more than 10 million inhabitants). Most of these will be situated in developing regions of the world.

 Statista states that North America is the most urbanized continent currently, with 82.0% of its population living in cities. Latin America and the Caribbean were also reported as having a high degree of urbanization - as about 79.0% of the population reside in cities.

• Europe is ranked third in terms of degree of urbanization. Here 75.0% of the population live in urban areas.



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• Many countries in Asia and Africa will face challenges in meeting the needs of their rapidly growing urban populations. This will be most noticeable in relation to housing, transportation, energy systems and other infrastructure, as well as for employment and basic services (such as education and healthcare).

Degree of Urbanization by Continent, 2020

Contents





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Internet of Things

Emerging Mega Trends



IoT Devices Today

In 2021, there were more than 10 billion active IoT devices.



IoT Devices in the Future

It is expected that the number of IoT devices in operation will surpass 25.4 billion by 2025.

30%

IoT Hardware

The most-notable change to the IoT sector will be around the emergence of new software that allows for connection between devices. Hardware still accounts for 30.0% of the total value of IoT technology, although trends suggest its global market value is decreasing.

• The global IoT market is expected to reach a value of USD 1,512.8 billion by 2026 (from USD 683.9 billion in 2019). That represents a CAGR of 12.0%.

• With the development of new wireless networking technologies, the emergence of advanced data analytics, a reduction in the cost of connected devices and increased cloud platform adoption, the IoT market is expected to keep growing at a considerable rate.

 Based on forecasts of over 7.33 billion mobile users by 2023 and more than 1.1 billion connected wearable devices by 2022, show the IoT is destined to become one of the smartest collective and collaborative systems in human history.



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Global IoT Market, in USD Billion, Between 2019-2026F

Contents





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5G

Emerging Mega Trends



Phone Usage

The Ericsson Mobility Report states that the monthly global average data usage per smartphone now exceeds 10GB, and this is forecast to reach 35GB by the end of 2026.



Horizon Project

Governments are investing in 5G in a bid to make hyper connected public services. For example, China has allotted over USD 30 billion to 5G research and development for the next five years. The European Commission (EC) has earmarked USD 1 billion to 5G as part of its Horizon 2020 project.



5G Coverage

In 2021, 5G coverage grew by a staggering 350.0% to cover 1,336 cities. As a result, 30.0% of the world's countries now have 5G coverage. A year earlier, there were only 378 cities that had 5G.

 According to estimates from Ericsson's latest edition of its Mobility Report, the number of 5G smartphone subscriptions worldwide passed 500 million in 2021, more than doubling the figure for 2020. In 2022, 5G subscriptions are on target to reach 1.1 billion and this is expected to climb to 3.4 billion during 2026.

 5G-led ubiquitous sensor networks will be at the foundation of smart city development. The unique ability of 5G networks to meet differentiated smart city needs will be pivotal in enabling greater collaborative intelligence.

• 5G technology can address the needs of smart healthcare. Through this, it will be possible for fair, accessible and inclusive healthcare reform to be promoted.



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• North America had an 89.3% share in LTE connections in Q4 of 2020. It was followed by Oceania, East and Southeast Asia at 78.4%, Western Europe at 69.73, then Latin America and the Caribbean at 57.59%.

• In Europe, the total benefit of a full 5G deployment for open innovation platforms will cost USD 53.2 billion. However, the benefit in doing so will amount to USD 240.0 billion.



Global 5G Subscription, in Millions, 2020-2026F

Contents

Overview Technological trends Challenges Smart Agriculture Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building Smart Infrastructure Contact us Follow us



Technological trends



Autonomous Vehicle

These will include drones delivering packages to various locations, service machines doing cleaning and restoration services, plus automated 'personal assistants' helping employees get more done faster and with greater precision.

They will be driven by the improved capabilities from chip vendors (e.g. Qualcomm, Intel, MediaTek, Broadcom, etc.), advanced and more abundant sensors (e.g. visual-based sensors, ultrasonic, touch, smell, LiDAR, etc.), high bandwidth low latency connections (e.g. 5G, Wi-Fi 6), and enhanced AI capabilities/algorithms (e.g. navigation, point-to-point scheduling, visual interpretations, etc.).



Private 5G

5G private networks are isolated either physically or virtually from public networks, using different hardware, virtual machines or network-slices.

Additionally, 5G private networks will further transform the factory floor. The three main components of 5G enhanced mobile broadband (eMBB), massive IoT and enhanced ultra-reliable low latency communications (eURLLC) - are utilized to connect a diverse set of devices in a factory. The 2020 3GPP Release 16 brought advanced support for 5G non-public networks (NPN), their defining characteristic being a network for private usage and not accessible to public users' navigation, point-to-point scheduling, visual interpretations, etc.)

DSA

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Domain-specific architectures (DSAs) will represent the future of artificial intelligence (AI) inference. They will enable adaptable hardware which can be customized, so that workloads may run at the highest possible efficiency. In 2022, AI inferencing will continue to move away from fixed silicon approaches and towards DSAs, helping to eliminate AI productization challenges. With this new ease of programming, FPGAs and adaptable SoCs will continue to become more accessible for hundreds of thousands of software developers and AI scientists - making them the hardware solution of choice for next generation applications.



Cloud Computing

The smart cities that will be so central to our future society will be underpinned by 5G communication, but also reliant on a number of other technologies if they are to function effectively. This is where cloud computing comes in. Approximately 6 billion people are predicted to live in smart cities by 2045 - that will mean significant computing capacity will be necessary. Cloud technology will provide the digital infrastructure for smart cities, functioning as a storage and analysis system for the data used in everything from autonomous vehicles to farming.

Contents

Overview

Technological trends

Challenges

Smart Agriculture Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building

Smart Infrastructure







Addressing the Challenges

What is required and what Murata can offer

 At the foundation of any form of smart city deployment will be the ongoing collection of large amounts of data. Through the analysis of this data, the various different services involved can be planned in ways that are the most efficient, environmentally friendly, responsive and cost-effective. Compiling all of this data calls for mass distribution of IoT devices.

 With the IoT devices being placed in locations that are difficult to reach, there is little or no opportunity for technicians to return to them once they have been deployed - the logistical costs would simply be too high. It is therefore vital that such hardware is built from high reliability components that will support long-term trouble-free operation. This will mean that the need for replacement or maintenance work can be avoided.

 In addition, plug-and-play solutions should ideally be chosen.
 This will minimize the set-up period and the engineering effort involved in configuration, calibration, etc. Smart city services can then be brought on-line in a much shorter time frame, meaning that citizens will see the benefits sooner.

 Murata offers a broad selection of relevant components parts, enabling customers to choose the best fit for their specific application requirements without having to make compromises.
 These are straightforward to install and deliver prolonged working lifespans.



Smart Cities • Application Guide

Contents

Overview>Technological trends>Challenges>Smart Agriculture>Smart Factory>Smart Health>Smart Mobility>Smart Home Appliances>Smart Security>Smart Building>Smart Infrastructure>







Smart Agriculture

Using technology to solve future food shortage problems

 With a continuously increasing global populace, combined with diminishing land reserves available for farming and access to a limited workforce, food production is reaching a state of crisis. Efforts must be made to ensure that supply can keep up with demand.

 Smart agriculture will see data captured from numerous sensor nodes - enabling various different ambient parameters (relating to the air, soil, light levels, etc.) to be monitored, as well as updates on the local weather conditions.

Because this hardware will be situated in an outdoor environment, it will need to be rugged enough to withstand extreme temperature variations, exposure to wind and rain, etc. Otherwise there will be a risk of malfunctions occurring.

• Crucial to the success of this monitoring work is 'barrier free' implementation. Use of wireless rather than wireline communication offers much greater convenience. It will be easier to add new nodes as they are required, or make changes to network arrangements.

Murata wireless modules are highly robust and reliable.
They represent a very lower total cost of ownership, as the need for repair and maintenance work is lessened considerably.
These modules are also compact and lightweight, enabling them to attend to AGV/drone applications.



Smart Cities • Application Guide

Contents

Overview Technological trends Challenges

Smart Agriculture

- Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building
- Smart Infrastructure





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Subscribe

> > > > > > > > > > > >

Soil sensor

Challenges in agricultural environments

The Murata soil sensor has been developed to continuously measure the conditions of many different agricultural environments.

The three-in-one package includes sensor elements for accurately determining electrical conductivity (EC), temperature, and moisture in terms of volumetric water content (VWC). As a result, this device is capable of measuring all three parameters simultaneously, eitherin soil or underwater. Specifically, the industry's first-ever nine-electrode EC sensor has multiple measuring patterns that help to eliminate uncertainty.

Measurement pattern example





FEATURES

EC sensor

- Electrical conductivity depends on contained anion/ cation amount. (NO3,NH4,H2PO4,K,Ca,Mg,Nacl etc..)

Temperature sensor

- Temp. in the soil and water environment.
- Moisture sensor - Measure the electric permittivity, translate to VWC.

PRODUCT SPECIFICATIONS

- Supply Voltage: 3.0-6.5 V
- Active current: 50 mA(max)
- **EC range:** 0-5.0 dS/m
- EC accuracy: ±3 F.S.
- Moisture range: 0-60 %VWC
- Moisture accuracy: ±3 % F.S.
- **Temperature range:** -20°C-70°C
- Temperature accuracy: ±1.1 °C
- Waterproof: IP68
- **Interface:** UART,RS232E,RS485,SDI-12
- Cable length: 3m@UART, 10m@RS232E, 300m@RS485 (Verified cable length)

ADVANTAGES

muRata

- Hardness, IP68
- Suitable for wireless transmission: Low power consumption Multi interface:

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Smart Agriculture Sensors

APPLICATIONS

- Long term soil condition monitoring for Agriculture.
- Agriculture irrigation system control - Long term river and pond water condition monitoring
- Aquaculture pond water condition control
- Powder dry monitoring and control
- Soil and water environment research





Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





• Simple interface:

Three sensors in one package

- High accuracy moisture measurement:
- No effect of saline and temp

• High accuracy EC:

Certainty and Ability for dry soil

Rugged and waterproof structure:

UART.RS232E.RS485.SDI-12

Wireless system:

2.4GHz original protocol, BLE

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NDIR CO2 sensor

Long-term stability using auto-calibration

Murata's CO2 sensor is a product that exhibits long-term stability and high measurement accuracy. Its maintainability is improved through an automatic calibration feature incorporated. This is based on a unique calibration curve algorithm and a dual wavelength non-dispersive infrared (NDIR) system. One wavelength is for measurement and the other for reference.





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Smart Agriculture Sensors

- Low influence of other gases
- by NDIR principle
- Excellent temperature
- characteristics and high accuracy
- Excellent long-term stability
- and high reliability by automatic
- calibration

PRODUCT SPECIFICATIONS

- **Operating temperature:** 0 to 50 °C
- Storage temperature: -20 to 50 °C
- Measurement range: 0 to 2000ppm, 0 to 3000ppm
- Accuracy: ± (50ppm+5% of reading) Typ. ± (30ppm+2.5% of reading)
- Long-term stability (drift): ±50ppm/Year @ 1000ppm
- Power input: AC/DC 24V, DC12V
- Peak power consumption: Avg. 0.5W/Max. 2.0W
- Output interface: Analog 0 to 5V
- Measurement interval: 5s
- **Dimensions:** 67x92x20mm

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





11

Subscribe

MonoBK[™] and UltraBK[™] Line-up | Small POL DC-DC converter



Output Current [A]





Smart Agriculture Power Solutions

12

Smart Home Appliances

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Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset: - Infineon (CYW43438)

Type 1LD .

- + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- Package: Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

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Smart Agriculture Connectivity



APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





13

Subscribe

Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption - Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate

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- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- **Chipset:** nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces: UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate: FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification



Smart Agriculture Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





14

Subscribe

UWB Modules Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection





TYPE 2BP

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.

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Smart Agriculture Connectivity



NP

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

• UWB Chip set : Qorvo DW3110/3120

2AB 550 102002

QOCVO

all around you

- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications
- Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC -

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

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FCCID:HSW-TVISC

1C:4492A-TV15C

55017725

1SC

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Smart Agriculture Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

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Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

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Smart Cities • Application Guide

Smart Agriculture Connectivity



APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Modular Solutions

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe

- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB

+ Bluetooth[®] 5.2 (SDIO)



Type 1YM

Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1





BT H4 UART BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM
- i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range Cost







Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM Wi-Fi 11 a/b/g/n/ac Bluetooth 5.1 NXP 88W8987 chipset

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Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4

Radio-only modules



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Type 1FX Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset Type 1DX Shielded ultra-small Wi-Fi 11b/g/n + Bluetooth 5.1 Cypress CYW4343W chipset Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset



• NXP i.MX

- ST Micro Linux[®]
- Micropython - Arduino Portenta H7 - Type 1DX

Soldered-down in major development platforms Wireless communications



- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

- STM32MPI Discovery Kit - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

Battery	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
Coin Manganese Dioxide Lithium (CR)	Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
	High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard



Smart Cities • Application Guide

Smart Agriculture Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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21

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> > > > > > > >

Smart Factory

Making industrial operations more efficient

• Within factory settings, there is now a shift away from outdated mechanical systems and increasing reliance on automation. This is resulting in industrial activities being run more efficiently - with reduced wastage, lower levels of pollution, less risk of downtime and substantial energy savings all being realized.

• Use of automated and robotic systems means that human operatives are not needed to carry out repetitive work, as such tasks can be offloaded. This is clearly advantageous, as it eliminates the possible threat of error through fatigue. It also means that staff can be assigned to other functions that will draw on their experience (thereby making their jobs more fulfilling).

• Through the use of high resolution magnetic sensor technology, control accuracy can be increased, with higher precision motion and position data being derived. This is enabling the performance of the actuators and motors in machinery to be improved reducing energy consumption and extending lifecycles, as well as safeguarding against potential damage.

• Wireless technology will be pivotal in upgrading older items of legacy equipment, so that they can be connected to Ethernetbased industrial automation infrastructure. This will need to run off minimal power reserves, so as to extend operational life.

• Thanks to advanced sensors, wireless modules, batteries and DC-DC converters, Murata now plays an important role in making factories smarter.



Smart Cities • Application Guide

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building Smart Infrastructure





Subscribe

TMR Sensors CT100: 1D Linear Sensor

High Linearity, High Resolution and Low Noise

The CT100 1D linear sensor is characterized by its wide dynamic range (covering \pm 50mT) and also exhibits industry-leading linearity (with a linear error of just \pm 0.5% at \pm 20mT).

These attributes enable improved measurement reproducibility and negate the need for compensation circuitry to address temperature fluctuations. The sensor supports a wide operating voltage range (1.0V to 5.5V). Among its main applications are linear measurements, proximity sensing and current sensing.



Linear sensor CT100 series (Analog)





Linear Encoders

Cylinder switch

Smart Cities • Application Guide

Smart Factory Sensors

FEATURES

Contactless

current sensor

- Excellent Linearity, < ±0.5%
 Highly accurate linear measurements.
- Stable Magnetic Performance
 over Temperature

- No compensation circuitry or software required to ensure consistent performance over temperature.

- Reduces development time and cost.

Low Current Consumption

 Draws about 167 µA @ VDD = 5.0 V
 which is more than 12x lower current
 than other 1D linear sensors.

Wide Supply Voltage Range

 No need for regulator to operate CT100 since it operates over wide range.
 Reduces cost, component count and solution footprint.

- Small Form Factor
- DFN-6 package occupies only 2.25 mm2 of PCB area.
- Ideal for mobile or wearable devices.

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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nces

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TMR Sensors CT310: 2D Angular Sensor

High Linearity, High Resolution and Low Noise

The CT310 is a 2D angular sensor with an operating magnetic range from 25mT to 90mT, plus differential outputs for both sine (SIN) and cosine (COS) axes. It is intended for angular position measurement and BLDC motor control. This device has a very low angular error of <0.6°, once amplitude normalization and offset cancellation have both been applied.







Smart Cities • Application Guide

Smart Factory Sensors

FEATURES CT 310

- Low Angular Error - High precision angle measurements.
- Stable Magnetic Performance over Temperature

- No compensation circuitry or software required to ensure consistent performance over temperature.

- Reduces development time and cost.

• Wide Supply Voltage Range

- No need for regulator to operate CT310 since it operates over wide range. - Reduces cost, component count and solution footprint.

Small Form Factor

- DFN-8 package almost 5x smaller in size than competing solutions.

- Ideal for mobile or wearable devices.

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





© Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022 24

Meter

Control knobs



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MonoBK[™] and UltraBK[™] Line-up | Small POL DC-DC converter



Output Current [A]





Smart Factory Power Solutions



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Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset: - Infineon (CYW43438)

Type 1LD .

- + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- **Package:** Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

Smart Cities • Application Guide



Smart Factory Connectivity



APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption - Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

- **Chipset:** nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces: UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate: FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

Type MBN52832 -



Smart Cities • Application Guide

Smart Factory Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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27

Subscribe

UWB Modules

Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection





TYPE 2BP

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.

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Smart Factory Connectivity



2AB 550 102002 QOCVO all around you

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications

 Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

FCCID:HSW-TVISC

1C:4492A-TV15C

55017725

1SC

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Smart Factory Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

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· BI003-180242 EBI003-180138003



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

Smart Cities • Application Guide



Smart Factory Connectivity



APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Modular Solutions

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe
- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (SDIO)



Type 1YM Dual band

Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1







BT H4 UART BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range
- Cost







Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM Wi-Fi11 a/b/g/n/ac

Bluetooth 5.1 NXP 88W8987 chipset



Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4

Radio-only modules



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Type 1FX Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset Type 1DX Shielded ultra-small Wi-Fi 11b/g/n + Bluetooth 5.1 Cypress CYW4343W chipset Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

• NXP i.MX

- ST Micro Linux[®]
- Micropython

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Smart Cities • Application Guide

Soldered-down in major development platforms Wireless communications



- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

- STM32MPI Discovery Kit - Type 1DX

- Arduino Portenta H7 - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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Subscribe

CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

Battery	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
Coin Manganese Dioxide Lithium (CR)	Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
	High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard



Smart Cities • Application Guide

Smart Factory Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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Subscribe

Smart Health

Improving the quality of life for patients and better utilizing medical resources

• The global smart health business is expanding rapidly. Precedence Research forecasts that it will be worth over \$482 billion by 2027.

 Until now medical activities were almost exclusively undertaken within a clinical setting. Over the last decade, however, this has changed. Now it is possible for a large proportion of this work to be done without the need for patients to visit a hospital or clinic.

• The data required by medical professionals can be obtained by employing home-based monitoring. This can be through the regular use of portable equipment, or continuous data acquisition via body-worn technology. The latest figures from Research and Markets estimate that there are now more than 50 million patients worldwide being monitored from their homes.

• Smart health can be of value in the remote treatment of patients, as well as for diagnostic reasons. Data from sensors can be examined to help improve drug delivery and to make certain that patients are administering their treatments correctly (such as smart insulin pens, etc.).

• At the foundation of home-based monitoring and treatment are lower power wireless and advanced battery technologies. Murata has batteries supporting long-term monitoring implementations and wireless modules to construct gateways for transporting data to the cloud for analysis.



Smart Cities • Application Guide

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure











Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset:

Type 1LD .

- Infineon (CYW43438) + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- **Package:** Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

TypeILD IBI 001-

CID: VPVLBILD CID: VPVLBILD CID: VPVLBILD CID: 2C-LBILD C: 712C-LBILD C: 712C-LBILD C: 558524005

Smart Cities • Application Guide



Smart Health Connectivity

APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption

 Tx 7mA @ 3.5dBm (DCDC mode)
 Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- Very small size: 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- Chipset: nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces:
 UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate:
 FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

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Smart Cities • Application Guide

Smart Health Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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37







UWB Modules

Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection





TYPE 2BP

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.

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2AB 550 102002 QOCVO

all around you

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications

 Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

FCCID:HSW-TVISC

rc-10-1127 - TMSC 1C:4492A-TMSC

55017725

1SC

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Smart Health Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

Þ



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building











LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

Smart Cities • Application Guide



Smart Health Connectivity



APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building











Modular Solutions

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe
- BT H4 UART
- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (SDIO)



Type 1YM Dual band

Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1







BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building











Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM
- i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range
- Cost

Smart Cities • Application Guide





Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building











A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset

ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM

Wi-Fi 11 a/b/g/n/ac Bluetooth 5.1 NXP 88W8987 chipset



Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Radio-only modules

Type 1FX

Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset

Type 1DX

- Shielded ultra-small Wi-Fi 11b/g/n
- + Bluetooth 5.1
- Cypress CYW4343W chipset

Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

- Micropython

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Soldered-down in major development platforms Wireless communications



• NXP i.MX

- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

 ST Micro – Linux[®] - STM32MPI Discovery Kit - Type 1DX

- Arduino Portenta H7 - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building











SR & LR **Batteries**

Micro Batteries

Ideal for high-performance medical devices that require large current loads for communication, lighting, camera, mechanical driving, etc.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Silver Oxide Batteries

• 100% made in Japan

• World leader in silver oxide batteries

• World's first mercury free SR batteries

THE WORLD'S NO.1 SUPPLIER OF SILVER OXIDE BATTERIES

	Manganaga	Detteries
Alkaline	Manganese	Batteries

- Excellent high-drain pulse discharge characteristics
- High safety with unique Technology preventing leakage & swelling
- 100% made in Japan



Battery	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
Alkaline Manganese (LR)	Standard High Drain	1.5V 1.5V	45-120mAh 150mAh	-10 to 60°C -10 to 60°C	Affordable, High drain High peak 120mA pulse (x3 times) vs. Standard
	Standard	1 551/	20-110mAb	-10 to 60°C	Stable discharge performance
Oxide (SR)	High Drain	1.55V	45-150mAh	-10 to 60°C	High peak 120mA pulse (x3 times) vs. Standard

Smart Cities • Application Guide



Smart Health Batteries



Contents

Overview Technological trends Challenges Smart Agriculture Smart Factory Smart Health Smart Mobility Smart Home Appliances Smart Security Smart Building Smart Infrastructure











CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

Battery	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
	Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
Coin Manganese Diavida	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
Lithium (CR)	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
	High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard

Smart Cities • Application Guide



Smart Health Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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Smart Mobility

Bringing us closer to an autonomous future

 One of the key elements of future smart cities is certain to be the automation of transportation networks and the removal of human involvement from driving. This will enable safer journeys for citizens, with there no longer being the prospect of accidents occurring. Rather than needing to worry about concentrating on the road, vehicle occupants will be able to simply relax and enjoy the ride.

 Industry analysts Statista has predicted that 1 in 10 vehicles will be fully autonomous by 2030. To support this shift away from human control, high accuracy movement predictions will be mandated. This will ensure that optimal distance between vehicles is kept to while they are travelling along highways.

 In addition, object detection will be critical - so that any potential danger on the road ahead can be rapidly reacted to (with evasive action being taken if necessary).

• Autonomous vehicles will need to communicate with nearby infrastructure and other vehicles. V2X will enable valuable information to be shared, with regard to congestion problems, speed restrictions, accidents, available parking spaces, etc.

 Murata's automotive-qualified sensor devices are being featured in many OEMs' smart mobility systems. MEMS-based inertial sensing devices provide accurate data on vehicle positioning and movement. Likewise, ultrasonic sensors are being employed for object detection purposes.



Smart Cities • Application Guide



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure









> > > > > > > > > > > > > > >

High accuracy MEMS sensor

3D MEMS technology enables higher performance at lower cost.

Murata offers high performance accelerometers, inclinometers, gyroscopes and combo sensors. Gyroscope components and combined sensors (including gyroscope and accelerometer) are based on our proven 3D MEMS technology and highly integrated electronics. Industrial gyroscopes offer a performance level that has typically been available only for expensive module products. All products are RoHS compatible and suitable for lead-free reflow soldering.

SCC2000 SCA3300



FEATURES

- Robust MEMS technology
- Field proven reliability & high performance in demanding applications
- Good offset stability over temperature and time
- High accuracy in demanding applications (eg, high temperature variation, high vibration environment, etc.)
- Excellent mechanical shock endurance
- Can withstand high impact/dropping

ACCELEROMETERS & GYROS

Recommended product	Product description
SCA3300	Digital SPI 3 axis accelerometer for inclination measurement
SCC2000	Digital SPI 1 axis gyro & 3 axis accelerometer (X or Z axis)
SCC3000	Digital SPI 2 axis gyro and 3 axis accelerometer
SCHA600	Digital SPI 3 axis gyro and 3 axis accelerometer



Smart Mobility Sensors

MURATA BENEFITS & ADVANTAGES:

• Gyroscope performance:

- Bias stability
- Low noise
- Accuracy

Accelerometer performance:

- Low noise
- Offset stability over temperature
- Good performance in vibrating environment



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure









> > > > > > > > > > > > > > >

Ultrasonic sensor

Low-cost solution for distance detection

Small and lightweight, ideally suited for short-distance range detection and home security.

APPLICATIONS

- Robotics (consumer use)
- Room layout scanning



Туре	Using method	Part number	Driving frequency (kHz)	Diameter (mm)	Capacitance (pF)	Directivity (degree, typ.)	Sound pressure level	Sensitivity	Max. Input voltage
	Transmitter	MA40S4S		9.9±0.3	2550±20%		120dB typ. (0db=0.02mPa)		20Vp-p Continuous signal
Орептуре	Receiver	MA40S4R	40	9.9±0.3	2550±20%	80		-63dB typ. (0db=10V/Pa)	



Smart Mobility

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure









Smart Home Appliances

Making living spaces more responsive to people's needs

• The more widespread use of automation in the home is bringing greater comfort to occupants. It also means that they do not have to dedicate as much time to their daily household chores and gives them the freedom to operate domestic appliances without needing to actually be there.

• Key to home automation is the integration of wireless technology. Through this, an increasing proportion of appliances are now becoming connected to the network - rather than just being standalone items that can only be operated by pressing a button or flicking a switch. Instead, actuators can be wirelessly controlled, allowing remote operation of appliances. The cooking of food in microwaves can be initiated, so that it is ready to eat when people return home. Likewise, washing machines may be turned on during the day, to avoid electricity consumption during peak pricing periods. There is also scope for smart refrigerators to check if the use-by dates of products they are storing have passed and then reorder these products.

• Household electricity and water consumption may be monitored to check that there is no unwanted wastage. Also indoor air quality management is starting to be addressed.

• Murata's low power wireless modules are enabling domestic appliances to interface with home automation systems and smart speakers. Magnetic sensors from Murata allow accurate flow metering. Furthermore, the IonissimoTM family of ionizer products are helping improve air quality within the home environment.



Smart Cities • Application Guide

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building









AMR magnetic sensor

Design flexibility, narrower sensitivity range and higher reliability

The AMR series consists of sensors that include an IC to detect changes in the magnetic resistance of a magneto resistive element that is effected by an external magnetic field. This is achieved from a ferromagnetic NiFe alloy thin film that is deposited over the IC circuit.

> **OPEN-CLOSE** DETECTION

MRMS543E

- **Part number:** MRMS20 series
- **Sensitivity (mT):** 0.5 to 2.5
- **Dimensions (mm):** 2.9×2.8×1.1
- Features:
- Std. performance, compact package
- Applications:
- Std. open-close, position detection - Low-speed rotation detection



Water meter

maRata

- Features:



Water boiler



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Smart Home Sensors

FLOW METERING BY **ROTATION DETECTION**



• **Part number:** MRSS29DR-001 • Sensitivity (mT): 1.2 to 3.2 • **Dimensions (mm):** 2.9x2.8x1.1

- High voltage operation (3.5 to 30V) - High speed detection (Typ. 5kHz) - Built-in voltage regulator

• Applications:

- Flow metering for industrial equipment

CYLINDER CONTROL BY POSITION DETECTION

- **Part number:** MRMS543E
- Sensitivity (mT): 0.5 to 3.1
- **Dimensions (mm):** 1.45x1.45x0.55
- Features:
- High accuracy, high-speed detection (Typ. 500Hz (min.))
- Built-in temp. compensation circuit
- Low voltage, low power operation
- **Applications:**
- Position, proximity detection
- High-speed rotation detection for industrial equipment
- **Part number:** MRMS541E
- **Sensitivity (mT):** 0.9 to 2.7
- **Dimensions (mm):** 1.45x1.45x0.55
- Features:
- Typ. 1kHz (min.)
- Built-in temp. compensation circuit
- **Applications:**
- Position, proximity detection
- High-speed rotation detection for industrial equipment



Cylinder control



Overview

Contents

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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50





Small, high efficiency ionizer

Ionissimo[™] MHM5 series

This highly reliable and highly safe ionizer module uses Murata's exclusive high-voltage circuit, insulation technology and generator structure design to efficiently generate ions at lower voltages. The module structure featuring the drive power supply wired to the ion generator provides a high degree of design freedom when incorporating the module into the finished product.

In addition, you can select the model that best matches your application, controlling the amount of ozone generated without changing the volume of ions.

SMALL, LOW-VOLTAGE IONIZER

The Ionissimo can effectively generate ions for a comfortable environment

- Ionizer's Ions clean the air dust (PM2.5) and keep moisture on the skin.
- Ionizer's lons remove static charged from objects.
- Ionizer's ozone kill virus/bacteria, sterilize any surface and prevent odor.
- Ionizer's ozone keep vegetable/fruits stay for long life and increase Vitamin.



ltems	Parts number	Input voltage	lon amount at 20cm	Ozone density
	MHM305 series	12Vdc	-5Mpcs/cc	0.04mg/h
	MHM306 series	12Vdc	-5Mpcs/cc	0.6mg/h
Ionizer	MHM314 series	12Vdc	-8Mpcs/cc	0.1mg/h
	MHM400 series (*1)	12Vdc	+5Mpcs/cc	0.1mg/h
	MHM402 series	230Vac	-4Mpcs/cc	0.4mg/h

*MHM400 series is for static eliminating application. If you would like to use other application, please contact us.







APPLICATIONS EXAMPLES

Air Conditioner Clean air from dust and smell



Air Purifier



Refrigerator Sterilize refrigerator and improve food freshness

Dishwasher



Washing Machine Dryer Machine Sterilize clothes and dish, preventing mold





Circulator and

Electric fan



Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building















Small, high efficiency ozonizer

Active Oxygen Module

This highly reliable and highly safe ozonizer module uses Murata's exclusive high-voltage circuit, insulation technology and generator structure design utilizing creepage discharge on the board surface to generate ozone more stably and efficiently.

The module structure featuring the drive power supply wired to the ion generator provides a high degree of design freedom when incorporating the module into the finished product.



SMALL, LOW-VOLTAGE OZONIZER

Active Oxygen module will help you to create clean space

- AO module's ozone kill virus/bacteria, sterilize any surface and prevent odor.
- AO module's ozone clean water and sterilize it.
- AO module's ozone keep vegetable/ fruits stay for long life and increase Vitamin.



Reduce **90.5%** virus after 20min with very low ozone density **0.1ppm**

Items	Parts number	Input voltage
	MHM500-00A	12Vdc
Active Oxygen	MHM501-00 (High reliability)	12Vdc
(Ozonizer)	MHM502-01A (High density Ozone)	12Vdc

Smart Cities • Application Guide



Smart Home Power Solutions

APPLICATIONS EXAMPLES

Air Conditioner Clean air from dust and smell



Refrigerator Sterilize refrigerator and improve food freshness

Dishwasher



Washing Machine Sterilize clothes and





Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Air Purifier -550 A 1 100 P

omissimo

Ozone

density

1.1mg/h

1.0mg/h

45mg/h



Dryer Machine dish, preventing mold





Circulator and

Electric fan



52





MonoBK[™] and UltraBK[™] Line-up | Small POL DC-DC converter



Output Current [A]





Smart Home Power Solutions

Contents

Overview

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure









Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset:

Type 1LD

- Infineon (CYW43438) + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- Package: Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

TypeILD IBI 001-

CID: VPVLBILD CI

Smart Cities • Application Guide



Smart Home Connectivity

APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





54 © Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022





Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption - Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- **Chipset:** nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces: UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate: FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

Smart Cities • Application Guide

Smart Home Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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55





UWB Modules

Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection





TYPE 2BP

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.

Smart Cities • Application Guide



Smart Home Connectivity



2AB 550 102002 QOCVO all around you

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





56 © Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022





LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most

suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications
- Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- RoHS: Yes
- Software Features: AT commands. IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

FCCID:HSW-TVISC

1C:4492A-TV15C

55017725

1SC



Smart Cities • Application Guide

Smart Home Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

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Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





© Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022 57





LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

Smart Cities • Application Guide

Smart Home Connectivity

APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

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58

Modular **Solutions**

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe

- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)

Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (SDIO)

Type 1YM

Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2

Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1

BT H4 UART BT PCM/I2S

Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0

Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0

Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

© Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022

59

Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM i.MX 7ULP uCOM

2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range
- Cost

Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

© Murata Manufacturing Co. Ltd. Ref: K4EU-1 • Apr 01 2022 60

A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.

Module with MCU

Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules

Type 1ZM

Wi-Fi11 a/b/g/n/ac Bluetooth 5.1 NXP 88W8987 chipset

Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4

Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Radio-only modules

Type 1FX

Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset

Type 1DX

- Shielded ultra-small Wi-Fi 11b/g/n
- + Bluetooth 5.1
- Cypress CYW4343W chipset

Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

NXP i.MX

- Micropython - Arduino Portenta H7 - Type 1DX

Soldered-down in major development platforms

Wireless communications

- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

 ST Micro – Linux[®] - STM32MPI Discovery Kit - Type 1DX

Arduino Portenta H7

i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

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61

CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.

Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

Battery		Туре	Nominal Voltage	Capacity	Operating Temp.	Features
		Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
Co Ma Dic Litl (CF	Coin Manganese Diovido	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
	Lithium (CR)	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
		High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard

Smart Cities • Application Guide

Smart Home Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

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62

Smart Security

Assuring safety within the home

 The smart home security sector is currently experiencing a compound annual growth rate (CAGR) of almost 20%, according to Verified Market Research. The analyst firm expects this sector to generate annual revenues of over \$8.5 billion by 2028.

• Previously, security systems tended to be mechanically based. Now ones that are electronically based are becoming more popular, better aligning with home automation systems. Flexible DIY platforms can be used to implement customized security systems.

• With increasing regularity, camera systems are being deployed around the exterior and interior of people's homes - enabling surveillance functions to be benefitted from. In addition, video doorbells are seeing widespread uptake.

 Sensors can be used for door/window positioning and motion detection. These must have strong immunity to the RF present around the home. They should also exhibit the ability to withstand exposure to intruders trying to use large magnets to trip locks.

As well as the energy efficient wireless modules utilized
for transferring data, Murata magnetic sensors are installed
into window and door opening/closing mechanisms, plus antitampering mechanisms. High RF immunity pyroelectric-based
PIR sensors are also being employed for motion detection,
alerting occupants of intruders. Murata batteries and PoE
DC-DC converters are enabling security systems to be powered.

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

nces

Subscribe

> > > > > > > >

AMR magnetic sensor

Design flexibility, narrower sensitivity range and higher reliability

The AMR series consists of sensors that include an IC to detect changes in the magnetic resistance of a magneto resistive element that is effected by an external magnetic field. This is achieved from a ferromagnetic NiFe alloy thin film that is deposited over the IC circuit.

APPLICATIONS

- Door opening detector
- Smart lock

Open-Close detection in Door opening detectors MRMS581P

maRata

Position detection in Thumbturn

Smart Cities • Application Guide

Smart Security Sensors

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Subscribe

Pyroelectric infrared sensor

Extra high sensitivity, lead-type pyroelectric infrared sensor

Our newly developed low-cost, high-sensitivity, high-RFI (Radio Frequency Immunity) and high-WLI (White Light Immunity) characteristic lead-type infrared sensor.

The IRA-S series has an improved RFI characteristic for the security market to comply with EN regulation for detection levels, such as peripheral circuitry. Its high sensitivity and high reliability make a great contribution to ergonomics and energy conservation for a wide range of appliances.

FEATURES

- Excellent immunity characteristic to electromagnetic waves
- Easy human movement detection
- Wide detection area using lens

PRODUCT SPECIFICATIONS

IRA-S200ST01A01 •

Ø = 9.2mm

SECURITY SYSTEM

- **Type:** Dual
- Part number: IRA-S200ST01A01
- Sensitivity (500K, 1Hz, mVp-p): 4.6
- **Dimensions (mm):** Ø9.2×4.7
- **Type:** Serial quad
- Part number: IRA-S400ST01A01
- Sensitivity (500K, 1Hz, mVp-p): 7.0
- **Dimensions (mm):** Ø9.2×4.7
- Benefits
- New and cost effective model
- High RFI (Radio Frequency Immunity)
- For security, automatic ECO switch for
- display and other appliance

Smart Security Sensors

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

65

Subscribe

Isolated DC-DC converters for PoE

PoE solution

An increasing number of network devices are utilizing PoE to eliminate the need for installing AC power supplies and in order to reduce wiring.

The expanding functionality and sophistication of these network devices is driving the need for miniaturization of the power supply section. The combination of these trends has led to Murata's development of the MYBSP series DC-DC converters. Incorporating hardware classification protocol functions that conform to the IEEE® 802.3af and at PoE communication standard, the product utilizes a sheettype transformer resulting in a miniaturized design with high dielectric strength.

PSE module

PD module

Lineup

		Power	Dimensions (mm)	Part number	Output	Adapter oring	T2P
	/ af	10W		MYBSP00502ABF	5V/2A	N/A	N/A
	PoE	12W	26x14.8x6	MYBSP01201ABF	12V/1A	N/A	N/A
For PD	- / at		.5W 35.5x22.4x10.55	MYBSP0055AABFT	5V/5.1A	Available	Available
	н 25.5 ОД	25.5 VV		MYBSP0122BABFT	12V/2.125A	Available	Available
For PSE	Boost-up	30W	35.5x22.4x8.9	MYBSS054R6EBF	54V/0.6A	N/A	N/A

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FEATURES

- Compliant to IEEE® 802.3af or IEEE® 802.3at
- Small and low profile SMD type
- Available at Ta=+85°C
- Low EMI
- 2250Vdc input-output isolation
- Fewer values of external capacitor

Smart Security Power Solutions

SMALL AND LOW PROFILE

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Features

- Compliant to IEEE[®] 802.3af class 0 operation Low profile SMD type
 Operating temperature range -40 to +85°C
 Low EMI : compliant with CISPR class A
 2250Vdc input-output isolation
 Compliant to IEEE[®] 802.3at class 4 operation Low profile SMD type
 Available continuous 25.5W at +85°C
- Low EMI : compliant with CISPR class B
- 2250Vdc input-output isolation
- Available T2P and adapter-oringNo external capacitor operation

Low profile SMD type

- Available from -40 to +85°C
- Operations input from 10.8V to 27V
- 2250Vdc input-output isolation

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Subscribe

> > > > > > > > >

MonoBK[™] and UltraBK[™] Line-up | Small POL DC-DC converter

Output Current [A]

Smart Security Power Solutions

Contents

Smart Agriculture

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Subscribe

Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

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Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

 Chipset: - Infineon (CYW43438)

Type 1LD .

- + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- **Package:** Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

TypeILD IBI 001-

CID: VPVLBILD CID: VPVLBILD IC: 712C-LBILD IC: 558524005

Smart Cities • Application Guide

Smart Security Connectivity

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Subscribe

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Type MBN52832

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FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption - Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- Chipset: nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces: UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate: FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

Smart Cities • Application Guide

Smart Security Connectivity

APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

69

Subscribe

UWB Modules Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

NO

- nents.

Smart Cities • Application Guide

Smart Security Connectivity

2AB 550 102002 D QOCVO all around you

TYPE 2DK

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Subscribe

LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications
- Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

FCCID:HSW-TVISC 550177725 1C:4492A-TV15C

1SC

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Smart Security Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

Þ

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

Subscribe

LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

Smart Cities • Application Guide

Smart Security Connectivity

APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure

72

Subscribe
Modular **Solutions**

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe

- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (SDIO)



Type 1YM

Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1



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BT H4 UART BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM
- i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range
- Cost





Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





Subscribe

A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM Wi-Fi11 a/b/g/n/ac

Bluetooth 5.1 NXP 88W8987 chipset



Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Shielded ultra-small Wi-Fi 11b/g/n Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW4343W chipset

Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

NXP i.MX

- ST Micro Linux[®]
- Micropython - Arduino Portenta H7 - Type 1DX



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Radio-only modules

Type 1FX

Cypress CYW43364 chipset

Type 1DX

- + Bluetooth 5.1

Soldered-down in major development platforms



- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

- STM32MPI Discovery Kit - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK



Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

B

Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

Coin Manganese Dioxide Lithium (CR)	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
	Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
	High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard



Smart Cities • Application Guide

Smart Security Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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> > > > > > > >

Smart Building

IoT solutions for smart buildings

 As well as making homes smarter, there are huge opportunities for greater automation within offices and residential buildings too. This will help to reduce the operational expenses of these locations, while curbing their energy consumption and minimizing their ecological impact.

Through data captured by wireless-enabled sensor devices,
 there is the prospect for heating, climate control and security
 functions to be attended to, plus energy control and occupancy
 management. Lighting and heating can be switched off in areas
 where there are no people present. Ventilation may be turned
 up in areas where the temperature is high (due to intense
 sunlight).

• Air quality management and occupancy gauging are becoming increasingly important to facilities managers.

• There is also a growing need for structural health monitoring of the buildings themselves - in order to make certain that there are no safety risks and to better schedule essential maintenance work.

• Murata is a key electronic component provider for smart building implementations - with a product portfolio that includes MEMS-based inertial sensors, PIR motion sensors and infra-red CO2 sensors. These are complemented by a wide array of different wireless modules and power solutions.



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







s > > > > > > > >

High accuracy **MEMS** sensor

3D MEMS technology enables higher performance at lower cost.

Murata offers high performance accelerometers, inclinometers, gyroscopes and combo sensors. Gyroscope components and combined sensors (including gyroscope and accelerometer) are based on our proven 3D MEMS technology and highly integrated electronics. Industrial gyroscopes offer a performance level that has typically been available only for expensive module products. All products are RoHS compatible and suitable for lead-free reflow soldering.



INCLINOMETERS

Recommended product	Product description	Accuracy	Features
SCL3300-D01	Digital SPI output 3 axis inclinometer	Accuracy ± 0.5 degree over operating temperature	 3-axis inclination sensor with digital true inclination angle output Four user selectable measurement modes for sensor performance optimization for different applications and their requirements Ultra-low noise density for high measurement resolution Mechanically damped sensing element design for excellent vibration robustness Extensive self-diagnostic features SPI digital interface -40 to +125 °C operating range Proven capacitive 3D-MEMS technology

ACCELEROMETERS & GYROS

Recommended product	Product description	Benefits	Features
SCA3300	Digital SPI 3 axis accelerometer for inclination measurement	Reliability	

FEATURES

Smart Cities • Application Guide



Smart Building Sensors

MURATA BENEFITS & ADVANTAGES:

- Gyroscope performance:
- Bias stability
- Low noise
- Accuracy

• Accelerometer performance:

- Low noise
- Offset stability over temperature
- Good performance in vibrating environment

- Robust MEMS technology
- Field proven reliability & high performance in demanding applications
- Good offset stability over temperature and time
- High accuracy in demanding applications
- (eg, high temperature variation, high vibration environment, etc.)
- Excellent mechanical shock endurance
- Can withstand high impact/dropping

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





>

Pyroelectric infrared sensor

Extra high sensitivity, lead-type pyroelectric infrared sensor

Our newly developed low-cost, high-sensitivity, high-RFI (Radio Frequency Immunity) and high-WLI (White Light Immunity) characteristic lead-type infrared sensor.

The IRA-S series has an improved RFI characteristic for the security market to comply with EN regulation for detection levels, such as peripheral circuitry. Its high sensitivity and high reliability make a great contribution to ergonomics and energy conservation for a wide range of appliances.

FEATURES

- Excellent immunity characteristic to electromagnetic waves
- Easy human movement detection
- Wide detection area using lens

PRODUCT SPECIFICATIONS

IRA-S200ST01A01 •

Ø = 9.2mm



- Type: Dual
- Part number: IRA-S200ST01A01
- Sensitivity (500K, 1Hz, mVp-p): 4.6
- **Dimensions (mm):** Ø9.2×4.7
- **Type:** Serial quad
- Part number: IRA-S400ST01A01
- Sensitivity (500K, 1Hz, mVp-p): 7.0
- **Dimensions (mm):** Ø9.2×4.7
- Benefits
- New and cost effective model
- High RFI (Radio Frequency Immunity)
- For security, automatic ECO switch for
- display and other appliance

LIGHTING CONTROL



Smart Buildings Sensors



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





s >

NDIR CO2 sensor

Long-term stability using auto-calibration

Murata's CO2 sensor is a product that exhibits long-term stability and high measurement accuracy. Its maintainability is improved through an automatic calibration feature incorporated. This is based on a unique calibration curve algorithm and a dual wavelength non-dispersive infrared (NDIR) system. One wavelength is for measurement and the other for reference.





Smart Buildings Sensors

- Low influence of other gases
- Excellent temperature
- characteristics and high accuracy
- Excellent long-term stability
- and high reliability by automatic
- calibration

PRODUCT SPECIFICATIONS

- **Operating temperature:** 0 to 50 °C
- Storage temperature: -20 to 50 °C
- Measurement range: 0 to 2000ppm, 0 to 3000ppm
- Accuracy: ± (50ppm+5% of reading) Typ. ± (30ppm+2.5% of reading)
- Long-term stability (drift): ±50ppm/Year @ 1000ppm
- Power input: AC/DC 24V, DC12V
- Peak power consumption: Avg. 0.5W/Max. 2.0W
- Output interface: Analog 0 to 5V
- Measurement interval: 5s
- **Dimensions:** 67x92x20mm

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure



80



>

Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset:

Type 1LD .

- Infineon (CYW43438) + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- Package: Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices



Smart Cities • Application Guide



Smart Building Connectivity



APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





81

>

Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption - Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and
- external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- Chipset: nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces: UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate: FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

Smart Cities • Application Guide



Smart Building Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





82

>

UWB Modules

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FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection







 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.





Smart Building Connectivity



2AB 550 102002 QOULO

all around you

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

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Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





83

>

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Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications
- Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone





Smart Cities • Application Guide

Smart Building Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

Þ



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





>

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This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

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Smart Cities • Application Guide

Smart Building Connectivity



APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





85

>

Modular Solutions

Wireless communications

M.2 boards

Our M.2 modules, co-developed by Embedded Artists, are designed for evaluation, integration and ease-of-use. These professionally designed and proven M.2 modules provide easy evaluation of different Wi-Fi®/Bluetooth® solutions, lower your risk and shorten your time to market.

FEATURES

- Standard M.2 form factor
- Reference-certified antennas & snap-off option
- UFL connectors for antenna or conducted testing
- Comprehensive interface support including SDIO, PCIe, UART, PCM, and radio control lines

µSD adapter

Murata's µSD-M2 adapter board offers an out-of-the-box experience for NXP i.MX with Murata's M.2 module family. All WLAN/BT- necessary signals are included on M.2 connector pins (Key 'E') including:

- WLAN SDIO
- WLAN PCIe
- BT H4 UART
- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band

Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (SDIO)



Type 1YM

Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1





BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





86

>

Fully Modular Systems

Wireless communications

Murata and Embedded Artists have developed a full modular system which offers IoT designers a quick, easy and cost-effective route to world-class connectivity.

Development kits are available for use as your evaluation/prototyping platform. The kits include the hardware and software components needed to get up-and-running with your software development on day 1.

- Easily evaluate different Wi-Fi/BT solutions – by just switching M.2 modules
- Fast-to-market integration
- Less regulatory burden
- Use certified antennas
- Re-use FCC certification

1. CHOOSE A COM/OEM BOARD

Embedded Artists have developed a suite of COM computer-on-module (COM) units and OEM boards, integrating all core components around a variety of NXP processors and microcontrollers:

- i.MX RT1062
- i.MX RT1052
- i.MX 8M Quad
- i.MX 8M Mini uCOM
- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM
- i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

There are two types of carrier boards: One for i.MXRT family boards (with a slot for the COM or OEM board) and one which is suitable for the MPU COM boards and offers...

- Support for i.MX8 designs
- Support for M.2 Key E interface (typically Wi-Fi®/BT), including advanced debug features developed in cooperation with Murata and Cypress
- Support for M.2 Key B interface (typically Cellular/SSD)
- Support for USB 3.0

3. PLUG IN YOUR CONNECTIVITY

Choose the Murata/Embedded Artists M.2 connectivity module appropriate for your application in terms of:

- Performance
- Range
- Cost

Smart Cities • Application Guide





Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





87

>

A Wide Range of Wireless

Communication Modules

Murata offers an extensive portfolio of wireless modules based on Cypress and NXP chipsets.

Modules with integrated MCUs are used in combination with Cypress WICED software. Wi-Fi® and Bluetooth® capabilities are also incorporated and the MCU can be used to run an application.

Other modules are radio-only and they can be used in combination with a MPU (Linux®) or MCU (RTOS).

These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM Wi-Fi11 a/b/g/n/ac

Bluetooth 5.1 NXP 88W8987 chipset



Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Type 1FX Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset Type 1DX Shielded ultra-small Wi-Fi 11b/g/n + Bluetooth 5.1 Cypress CYW4343W chipset Type 1LV Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0

Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

NXP i.MX

- Micropython - Arduino Portenta H7 - Type 1DX



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Smart Cities • Application Guide

Radio-only modules

Soldered-down in major development platforms Wireless communications



- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

 ST Micro – Linux[®] - STM32MPI Discovery Kit - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





88

>

Smart Infrastructure

Maximizing the efficiency of energy usage

 Smart metering is now an essential element of modern commercial and residential buildings. Through it, utility bills can be kept in check and significant environmental benefits realized.

Research published by Wood Mackenzie Power & Renewables
 states that yearly investment in advanced metering infrastructure
 is continuing to rise. It will surpass \$127 billion by 2025, with close
 to 1.3 billion smart meters in operation globally by that time.

 Smart grid networks require streams of constantly updated data. By leveraging bi-directional communication, supply can be correctly matched with demand.

Wireless hardware based on cellular IoT protocols (Cat-M1 and NB-IoT) is proving extremely popular in a smart grid context.
It allows reasonable amounts of data to be transferred at very low power, while also being simple to implement (as supporting gateway infrastructure does not have to be put in place).

 Murata magnetic sensors are being widely deployed for measuring gas flow and water flow. Alongside these, there are the low power wireless modules for carrying the data required by smart grids, plus the batteries and DC-DC converters for powering this hardware.



Smart Cities • Application Guide

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





nces



AMR magnetic sensor

Design flexibility, narrower sensitivity range and higher reliability

The AMR series consists of sensors that include an IC to detect changes in the magnetic resistance of a magneto resistive element that is effected by an external magnetic field. This is achieved from a ferromagnetic NiFe alloy thin film that is deposited over the IC circuit. We offer more than 30 models that support a broad range of applications backed by our experienced design consulting service.

FEATURES

- Excellent immunity characteristic to electromagnetic waves
- Easy human movement detection
- Wide detection area using lens

MRUS74S 1.5 mm x 1.8mm

maRata

- Features:

OPEN-CLOSE DETECTION

- **Part number:** MRMS20 series
- **Sensitivity (mT):** 0.5 to 2.5
- **Dimensions (mm):** 2.9×2.8×1.1
- Features:
- Std. performance, compact package
- Applications:
- Std. open-close, position detection - Low-speed rotation detection



Water meter



Smart Cities • Application Guide

Smart Infrastructure Sensors

FLOW METERING BY **ROTATION DETECTION**

• Part number: MRSS29DR-001 • Sensitivity (mT): 1.2 to 3.2 • **Dimensions (mm):** 2.9×2.8×1.1

- High voltage operation (3.5 to 30V) - High speed detection (Typ. 5kHz) - Built-in voltage regulator

• Applications:

- Flow metering for industrial equipment



CYLINDER CONTROL BY POSITION DETECTION

- **Part number:** MRMS543E
- Sensitivity (mT): 0.5 to 3.1
- **Dimensions (mm):** 1.45×1.45×0.55
- Features:
- High accuracy, high-speed detection (Typ. 500Hz (min.))
- Built-in temp. compensation circuit
- Low voltage, low power operation
- Applications:
- Position, proximity detection
- High-speed rotation detection for industrial equipment

• **Part number:** MRMS541E

- Sensitivity (mT): 0.9 to 2.7
- **Dimensions (mm):** 1.45x1.45x0.55
- Features:
- Typ. 1kHz (min.)
- Built-in temp. compensation circuit
- Applications:
- Position, proximity detection

- High-speed rotation detection for industrial equipment



Cylinder control

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





90



NDIR CO2 sensor

Long-term stability using auto-calibration

Murata's CO2 sensor is a product that exhibits long-term stability and high measurement accuracy. Its maintainability is improved through an automatic calibration feature incorporated. This is based on a unique calibration curve algorithm and a dual wavelength non-dispersive infrared (NDIR) system. One wavelength is for measurement and the other for reference.



characteristics and high accuracy Excellent long-term stability and high reliability by automatic calibration



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Smart Infrastructure Sensors

- Low influence of other gases
- Excellent temperature

PRODUCT SPECIFICATIONS

- **Operating temperature:** 0 to 50 °C
- Storage temperature: -20 to 50 °C
- Measurement range: 0 to 2000ppm, 0 to 3000ppm
- Accuracy: ± (50ppm+5% of reading) Typ. ± (30ppm+2.5% of reading)
- Long-term stability (drift): ±50ppm/Year @ 1000ppm
- Power input: AC/DC 24V, DC12V
- Peak power consumption: Avg. 0.5W/Max. 2.0W
- Output interface: Analog 0 to 5V
- Measurement interval: 5s
- **Dimensions:** 67x92x20mm

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





91



MonoBK[™] and UltraBK[™] Line-up | Small POL DC-DC converter



Output Current [A]

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Smart Infrastructure Power Solutions

Contents

Smart Agriculture

Smart Home Appliances

Smart Security

Smart Infrastructure





Wi-Fi[®] Smart Module

Wireless communications

Type 1LD

Murata is market leader in Wi-Fi® modules for embedded systems, providing superior quality, elevated performance modules for high volume production.

Murata's wireless modules will streamline your assembly operations, thus significantly reducing customer's design time. Additionally, we offer a variety of low-power products for sensor networks.

FEATURES

- Highly integrated
- FCC/IC/CE/TELEC compliant
- Shielded Ultra Small Wi-Fi[®] 11b/g/n + Bluetooth[®] 5.2 + MCU Module

PRODUCT SPECIFICATIONS

Chipset: - Infineon (CYW43438)

Type 1LD .

- + STM32 (ARM Cortex-M4F)
- **Size:** 8.9 x 7.8 x 1.2 mm
- Peripheral Interface: GPIO/SPI/UART/I2C/ADC/PWM
- **Operating Temperature:** -40°C to 85°C
- **Package:** Shielded Resin Feature rich software hosted on module 802.11 b/g/n 65Mbps, Wi-fi® Stack runs inside, 1MB Flash, 256KB RAM Infineon WICED, SPP on Bluetooth® and GATT on Bluetooth® LE are supported by WICED Qualified for AWS IoT Core devices

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Smart Cities • Application Guide

Smart Infrastructure Connectivity



APPLICATIONS

- Home and building automation
- Lighting control
- Heating, Ventilation, Air-conditioning
- Energy management system (EMS)
- Simple sensor network
- Home security
- Healthcare & fitness



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







Bluetooth® Low Energy Module

Wireless communications

Type MBN52832

BLE is an ultra-low power communication technology that enables several years of operation off a button battery. Widespread adoption is being seen in fields like health management, fitness and home networks. BLE has also been adopted as a communication method by the Continua Health Alliance, a non-profit organization of healthcare and technology companies.

FEATURES

- Powerful MCU core with large RAM and flash for user application
- ARM Cortex M4; 64K RAM; 512K flash
- Low power consumption
 Tx 7mA @ 3.5dBm (DCDC mode)
- Rx 6mA (DCDC mode)
- Rich peripheral interface-20 GPIO ports
- **Very small size:** 7.4x7.0x0.9mm (max.)
- Fully certified
- FCC (US), IC (Canada), ETSI (EU), TELEC (Japan) - BT SIG Certificate
- Support both on-board and external antenna version
- On-board PCB pattern antenna
- External patch antenna
- External dipole antenna
- Bluetooth[®] 5.0

PRODUCT SPECIFICATIONS

Type MBN52832 -

- Chipset: nRF52832 Bluetooth® LE IC
- **Dimension:** 7.4x7.0x0.9mm
- Package: LGA
- Antenna: on-board or external
- **Max output power:** +4dBm (LDO mode)
- Interfaces:
 UART, SPI, 20 GPIO, 5ADC, SWD, PWM, I2C
- Operating voltage: 1.7V to 3.6V
- Operating temperature range: -40 to 85°C
- OTA firmware upgrade
- RoHS compliant
- Regulatory certificate:
 FCC/IC/ETSI/TELEC
- Bluetooth® SIG qualification

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Smart Cities • Application Guide

Smart Infrastructure Connectivity



APPLICATIONS

- Proximity services
- Building automation
- Medical/healthcare
- Bluetooth beacons



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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UWB Modules Wireless communications

Ultra-wideband (UWB) technology provides a highly effective means for providing secure and precise distance measurement. This is based on determining the time-of-flight (ToF) of radio waves. Murata offers an extensive portfolio of UWB modules.

FEATURES

- Ultra-small dimensions
- High quality
- Lower power consumption

APPLICATIONS

- Indoor navigation
- Smart retail/point-of-sales
- Smart building
- Smart locks
- Tags/tracking
- Contactless presence detection





TYPE 2BP

 Ultra small UWB module which includes NXP's SR150 UWB chipset, clock, filters and peripheral components.

- 3 Antenna support (3D AoA or 2D AoA support)
- UWB Chip set: NXP Trimension SR150
- Antenna: External

TYPE 2DK

- nents.

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Smart Cities • Application Guide

Smart Infrastructure Connectivity



2AB 550 102002 QOCVO all around you

 All-in-one UWB + Bluetooth LE combo module which integrates NXP Trimension[™] SR040 UWB Chipset, NXP QN9090 Bluetooth LE + MCU chipset, On board antenna and peripheral compo-

 Ideally suited for UWB Tag/Tracker which operates by coin-cell battery, and general IoT devices.

• **UWB Chip set:** NXP Trimension[™] SR040

• Antenna: Integrated

TYPE 2AB

- UWB Chip set : Qorvo DW3110/3120
- FCC/IC/TELEC Reference Certified (Planed)
- Hostless module Integrated Nordic IC / nRF52840

which also have Blutooth Low Energy function for waking up UWB and updating FW.

 Integrated 3-Axis sensor for saving battery

• Reference clock for UWB and MCU are embedded

- **UWB Chip set:** Qorvo DW3110/3120
- Antenna: External

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







LPWA Modules Wireless communications

Low power wide area (LPWA) networks provide a power efficient wireless communication technology for interconnecting devices together over a long range. LPWA is most suitable for applications such as IoT and machine-to-machine (M2M) communication, as well as various other situations where lower cost and lower power consumption are required. To respond to customers' needs, Murata has formed strategic partnerships with market leaders, and is accelerating the development of products using this highly appealing emerging technology.

Type 1SC

The Type 1SC (LBAD00XX1SC) module is the world's smallest **Cat. M1/NB-IoT module** with global certification. It supports GPS/GNSS, OpenMCU, Integrated SIM.

Murata has partnered with Truphone, making MVNO network communications possible through the use of eSIM.

FEATURES

- Small size Size attractive to wearables that previously had no means of cellular connectivity
- Standardized Through PTCRB/GCF certification improved global interoperability with global wireless networks operators for IoT applications
- Low power Protocol designed specifically for low current consumption extending battery lifetime up to 10+ years

PRODUCT SPECIFICATIONS

Type 1SC ←

LBAD0XX1SC

- Support LTE Band: Low Bands 5,8,12,13,14 (CAT M1 Only), 17,18,19,20,26,28 - Mid Bands 1,2,3,4,25
- **Chipset**: Altair ALT1250
- Modulation: LTE Cat.M1/NB-IoT Release 13 (*Release 14 – SW Upgrade)
- Antenna: External
- **Type Package:** Resin Mold
- **Dimension**: 11.1 x 11.4 x 1.5 mm (max)
- Transmit Power: +23dBm max
- Sleep Mode Current: eDRX Current Consumption (avg)/LTE-M: 43 uA PSM Current Consumption (avg)/LTE-M: 1.4 uA
- **RoHS:** Yes
- Software Features: AT commands, IPv4/IPv6 stack with TCP and UDP protocol, SSL/TLS, MQTT, OpenMCU(Optional), GPS/ GLONASS(Optional), iUICC(Optional)
- Certified: FCC/IC/RED/TELEC/KC/NCC GCF/PTCRB
- Certified Carrier: AT&T, KT, SKT, Pelion, Deutsch Telekom, Vodafone, Softbank, KDDI, Docomo, Soracom, Truphone

Smart Cities • Application Guide

Smart Infrastructure Connectivity

APPLICATIONS

- Smart metering
- Smart parking
- Home security/home automation
- Vehicle fleet management
- Wearables/trackers
- Industrial M2M communication
- IoT edge nodes

BLOCK DIAGRAM

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BI003-180242 BI0138003 TD180138003

FCCID:HSW-TVISC

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1C:4492A-TV15C

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1SC



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







LPWA Modules Wireless communications

Type 1SJ

The Type 1SJ (LBAA0QB1SJ) module is one of the smallest **LoRaWAN™** modules in the industry.

This module has a lower power consumption and higher output than previous products. Radio Law certification has already been obtained for major regions.

Open MCU design support is available.

FEATURES

- Compact and low cost
- Battery life 10 years
- Low Range 10km
- Pre-certified radio regulatory approvals 868 & 915 MHz spectrum

PRODUCT SPECIFICATIONS

• **RF/BB chipset:** SX1262

Type 1SJ 🔶

LBAA0QB1SJ

- **MCU chipset:** STM32L0 series CPU: Cortex M0+ RAM: 20KB Flash: 192KB
- Peripheral interfaces: UART/SPI/I2C/GPIOs/ADC
- Radio certification: FCC, IC, CE
- **Module size:** 10.0x8.0x1.60mm
- **Package:** Shielded Resin Mold
- **Frequencies:** EU / US / India / Pacific
- Operating temp: -40 to +85 °C
- Supply voltage: 2.2V to 3.6V
- RF transmit power: +14dBm / +21.5dBm
- **RF sensitivity:** -135dBm
- Frequency band: 860MHz-930MHz

包 🗲 주 🕅

Smart Cities • Application Guide

Smart Infrastructure Connectivity



APPLICATIONS

- Smart metering
- Smart lighting
- Smart parking
- Smart agriculture
- Industrial M2M
- IoT edge nodes



Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





97



Modular **Solutions**

Wireless communications

M.2 boards

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- WLAN SDIO
- WLAN PCIe

- GPIOs

Type 1XA Dual band Wi-Fi®11a/b/g/n/ac 2x2 MIMO / RSDB + Bluetooth[®] 5.2 (PCIe)



Type 1XZ Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO / RSDB

+ Bluetooth[®] 5.2 (SDIO)



Type 1YM

Dual band Wi-Fi® 11a/b/g/n/ac 2x2 MIMO + Bluetooth[®] 5.2





Type 1DX Wi-Fi® 11b/g/n + Bluetooth[®] 5.1

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BT H4 UART BT PCM/I2S





Type 1MW Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1LV Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.0



Type 1ZM Dual band Wi-Fi® 11a/b/g/n/ac + Bluetooth[®] 5.1

Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







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- i.MX 8M Nano uCOM
- i.MX 6Quad
- i.MX 6DualLite
- i.MX 6Ultralite
- i.MX 6SoloX
- i.MX 7Dual
- i.MX 7Dual uCOM • i.MX 7ULP uCOM



2. PLUG INTO COM CARRIER BOARD

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- Support for USB 3.0

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- Range
- Cost

包 🗲 🛜





Power consumption

 Temperature range Supported standards

4. START YOUR EVALUATION

- Pre-loaded software drivers
- Comprehensive user manuals
- Responsive support



Contents

Overview Technological trends Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







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These modules cover a wide array of different specifications - from single band Wi-Fi® 2.4GHz to dual band Wi-Fi® 11ac 2.4GHz and 5GHz with MIMO. Most of the options also include Bluetooth®.

With this variety of wireless modules Murata can cover a diverse breadth of applications - going all the way from small connected gadgets or sensor nodes to high data rate video streaming devices.



Module with MCU



Type ABR 802.11 b/g/n WiFi NXP 88MW320 chipset ARM Cortex-M4 200MHz

Radio-only modules



Type 1ZM

Wi-Fi11 a/b/g/n/ac Bluetooth 5.1 NXP 88W8987 chipset



Modules with MCU

Type 1LD

Shielded ultra-small Wi-Fi

- 11b/g/n+Bluetooth 5.2 + MCU
- Cypress CYW43438 chipset
- STM32 (ARM Cortex-M4F) MCU

Type 1GC

Shielded ultra-small dual band Wi-Fi 11a/b/g/n + Ethernet + MCU

- Cypress CYW43907 chipset
- Processor: ARM Cortex-R4

Radio-only modules



Many of Murata's extensive range of wireless modules are designed into leading development platforms. These include Linux®, FreeRTOS, etc.

Type 1FX Shielded ultra-small Wi-Fi 11b/g/n Cypress CYW43364 chipset Type 1DX Shielded ultra-small Wi-Fi 11b/g/n + Bluetooth 5.1 Cypress CYW4343W chipset Type 1LV

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43012 chipset

Type 1MW

Shielded ultra-small dual band Wi-Fi 11a/b/g/n/ac + Bluetooth 5.0 Cypress CYW43455 chipset

• NXP i.MX

- ST Micro Linux[®]
- Micropython - Arduino Portenta H7 - Type 1DX



Smart Cities • Application Guide

Soldered-down in major development platforms Wireless communications



- i.MX 8M Mini EVK - Type 1MW - i.MX 8M Nano EVK - Type 1MW - i.MX 7ULP EVK - Type 1DX - i.MX RT Alexa Voice Board - Type 1DX

Cypress WICED

- PSoC® 6 WiFi-BT Pioneer Board & - Prototyping Kit - Type 1DX/Type 1LV - CYW43907 Eval Kit - Type 1GC

- STM32MPI Discovery Kit - Type 1DX

Arduino Portenta H7



i.MX 8M Nano EVK

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure







CR Batteries

Micro Batteries

Murata offers a wide range of primary micro batteries with high performance and reliability, taking advantage of 40+ years technology development and manufacturing expertise.

FEATURES

- 40+ years technology development and manufacturing expertize.
- Acquisition of ISO 9001/14001 certification.
- Full automated assembling lines with high productivity.





Lightweight, High Voltage and High Energy Density

The battery voltage is 3V, almost double that of normal alkaline or manganese batteries.

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Excellent discharge characteristics

Voltage characteristics remain stable even for a long period of discharge.

Excellent long-term reliability

Murata's innovative sealing technology minimize battery self-discharge.

attery	Туре	Nominal Voltage	Capacity	Operating Temp.	Features
Coin Manganese Dioxide Lithium (CR)	Standard	3.0V	30-1000mAh	-30 to 70°C	Lineup of 10 models from small size and thin models to high capacity models
	Extended Temp.	3.0V	220-2000mAh	-40 to 85°C	Good balance between wide operating temperature and affordability
	Heat resistant	3.0V	210-1000mAh	-40 to 125°C	Wide operating temperature
	High Drain	3.0V	200-500mAh	-30 to +70°C	High peak 50mA pulse (x2 times) vs. Standard

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Smart Cities • Application Guide

Smart Infrastructure Batteries

Coin Manganese Dioxide Lithium Batteries

- High voltage, high energy density
- Wide range; including heat-resistant models
- ISO/TS16949 certified

Contents

Overview

Technological trends

Challenges

Smart Agriculture

Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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Global Locations

For details please visit www.murata.com

\triangle Note

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- Power plant equipment
 Modical equipment
- Medical equipment
 Transportation equipment
- Transportation equipment (vehicles, trains, ships, etc.)
 Traffic cianal equipment
- Traffic signal equipment
 Disaster prevention / crime prevention
- (8) Disaster prevention / crime prevention equipment
 (9) Data-processing equipment
- Data-processing equipn Application of similar co
- Application of similar complexity and/or reliability requirements to the applications listed above

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Smart Cities • Application Guide

No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.



Contents

Overview Technological trends Challenges

Smart Agriculture Smart Factory

Smart Health

Smart Mobility

Smart Home Appliances

Smart Security

Smart Building

Smart Infrastructure





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